

STF27N60M2-EP

N-channel 600 V, 0.150 Ω typ., 20 A MDmesh™ M2 EP Power MOSFET in TO-220FP package

Datasheet - production data

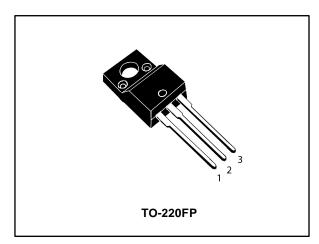
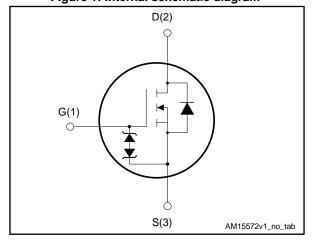


Figure 1: Internal schematic diagram



Features

Order code	V DS	R _{DS(on)} max	I _D
STF27N60M2-EP	600 V	0.163 Ω	20 A

- Extremely low gate charge
- Excellent output capacitance (C_{OSS}) profile
- Very low turn-off switching losses
- 100% avalanche tested
- Zener-protected

Applications

- Switching applications
- Tailored for very high frequency converters (f > 150 kHz)

Description

These devices are N-channel Power MOSFETs developed using MDmesh™ M2 EP enhanced performance technology. Thanks to their strip layout and an improved vertical structure, these devices exhibit low on-resistance, optimized switching characteristics with very low turn-off switching losses, rendering them suitable for the most demanding very high frequency converters.

Table 1: Device summary

Order code	Marking	Package	Packing
STF27N60M2-EP	27N60M2EP	TO-220FP	Tube

Contents STF27N60M2-EP

Contents

1	Electric	al ratings	3
2	Electric	cal characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	·cuits	8
4	Packag	e information	9
	4.1	TO-220FP package information	10
5	Revisio	n history	12

STF27N60M2-EP Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate-source voltage	± 25	V
$I_D^{(1)}$	Drain current (continuous) at T _C = 25 °C	20	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	13	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	80	Α
P _{TOT}	Total dissipation at T _C = 25 °C	30	W
dv/dt ⁽³⁾	Peak diode recovery voltage slope	15	V/ns
dv/dt ⁽⁴⁾	MOSFET dv/dt ruggedness	50	V/ns
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; T_c = 25 °C)	2.5	kV
T _{stg}	Storage temperature	55 to 150	°C
Tj	Operating junction temperature	- 55 to 150	

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
$R_{\text{thj-case}}$	Thermal resistance junction-case max	4.2	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	62.5	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter		Unit
I _{AR}	Avalanche current, repetetive or not repetetive (pulse width limited by T_{jmax})	3.6	Α
E _{AS}	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$; $V_{DD} = 50$ V)	260	mJ

⁽¹⁾Limited by maximum junction temperature

 $[\]ensuremath{^{(2)}}\mbox{Pulse}$ width limited by safe operating area.

 $^{^{(3)}}I_{SD} \le 20$ A, di/dt ≤ 400 A/µs; V_{DS(peak)} < V_{(BR)DSS}, V_{DD} = 400 V.

 $^{^{(4)}}V_{DS} \le 480 \text{ V}$

Electrical characteristics STF27N60M2-EP

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 5: On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	600			V
	Zoro goto voltago droin	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}$			1	μΑ
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V},$ $T_{C} = 125 \text{ °C}$			100	μΑ
I _{GSS}	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			±10	μΑ
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 10 A		0.150	0.163	Ω

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	1320	1	pF
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz, V _{GS} = 0 V	-	70	ı	pF
C _{rss}	Reverse transfer capacitance		-	1	-	pF
Coss eq. (1)	Equivalent output capacitance	$V_{DS} = 0$ to 480 V, $V_{GS} = 0$ V	-	146	ı	pF
R _G	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A	-	4	-	Ω
Q_g	Total gate charge		-	33	ı	nC
Q_{gs}	Gate-source charge	V _{DD} = 480 V, I _D = 20 A, V _{GS} = 10 V (see <i>Figure 15: "Test circuit for gate charge behavior"</i>)	-	5.2	ı	nC
Q_{gd}	Gate-drain charge	,	-	16	-	nC

Notes:

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	V 200 V I 10 A P 4 7 O	-	13.4	-	ns
t _r	Rise time	V_{DD} = 300 V, I_{D} = 10 A, R_{G} = 4.7 Ω , V_{GS} = 10 V (see Figure 14: "Test circuit for resistive load switching times" and Figure 19: "Switching time waveform")		8.1	-	ns
t _{d(off)}	Turn-off- delay time			55.6	1	ns
t _f	Fall time		-	6.3	-	ns

 $^{^{(1)}}C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 8: Source-drain diode

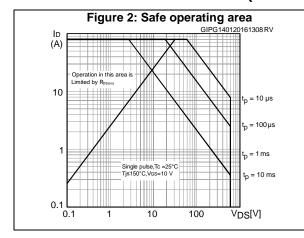
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		20	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		80	Α
V _{SD} ⁽²⁾	Forward on voltage	V _{GS} = 0 V, I _{SD} = 20 A	-		1.6	V
t _{rr}	Reverse recovery time		-	271		ns
Q _{rr}	Reverse recovery charge	I _{SD} = 20 A, di/dt = 100 A/µs, V _{DD} = 60 V (see Figure 19: "Switching time waveform")		3.44		μC
I _{RRM}	Reverse recovery current			25.4		Α
t _{rr}	Reverse recovery time		-	352		ns
Q _{rr}	Reverse recovery charge	$I_{SD} = 20$ A, di/dt = 100 A/ μ s, $V_{DD} = 60$ V, $T_{j} = 150$ °C (see <i>Figure 19: "Switching time waveform"</i>)		4.82		μC
I _{RRM}	Reverse recovery current	,	-	27.4		Α

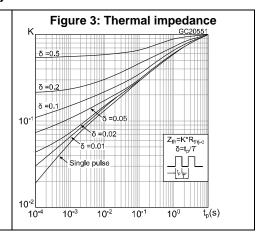
Notes:

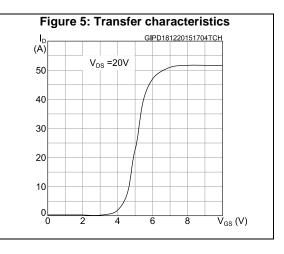
 $^{^{(1)}}$ Pulse width is limited by safe operating area

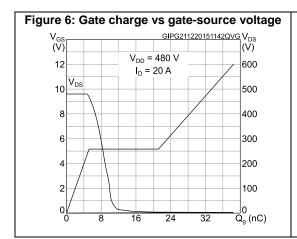
 $^{^{(2)}\}text{Pulsed:}$ pulse duration = 300 $\mu\text{s,}$ duty cycle 1.5%

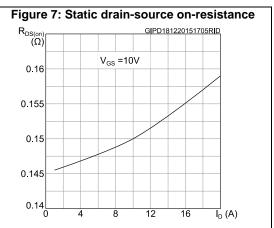
2.1 Electrical characteristics (curves)











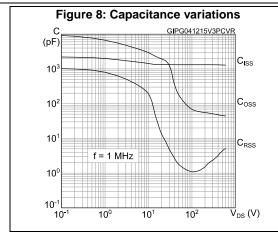
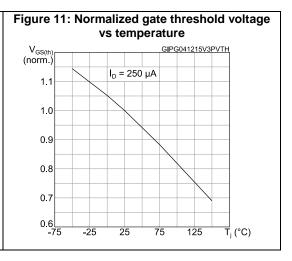
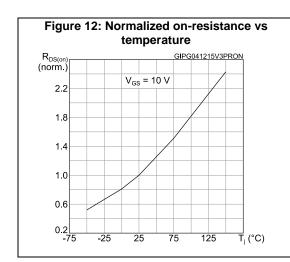


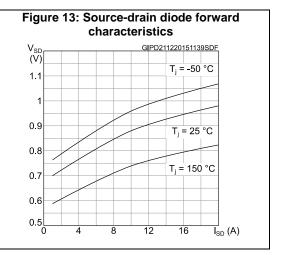
Figure 9: Output capacitance stored energy

Eoss GIPG041215V3PEOS
(µJ)
10
8
6
4
2
0
0 100 200 300 400 500 600 V_{DS} (V)

Figure 10: Normalized V(BR)DSS vs temperature V_{(BR)DSS} (norm.) GIPG041215V3PBDV I_D = 1 mA 1.08 1.04 1.00 0.96 0.92 0.88 -75 -25 25 75 125 T_j (°C)





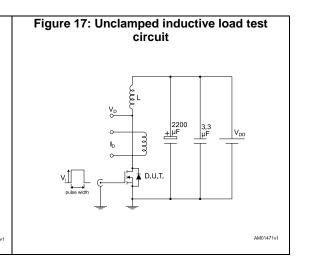


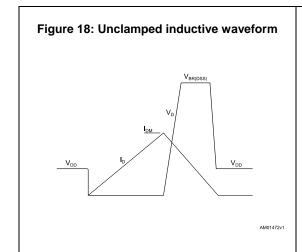
Test circuits STF27N60M2-EP

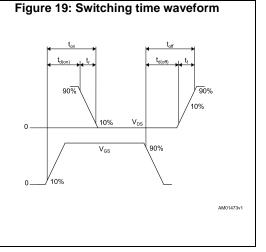
3 Test circuits

Figure 14: Test circuit for resistive load switching times

Figure 16: Test circuit for inductive load switching and diode recovery times







577

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO-220FP package information

Figure 20: TO-220FP package outline

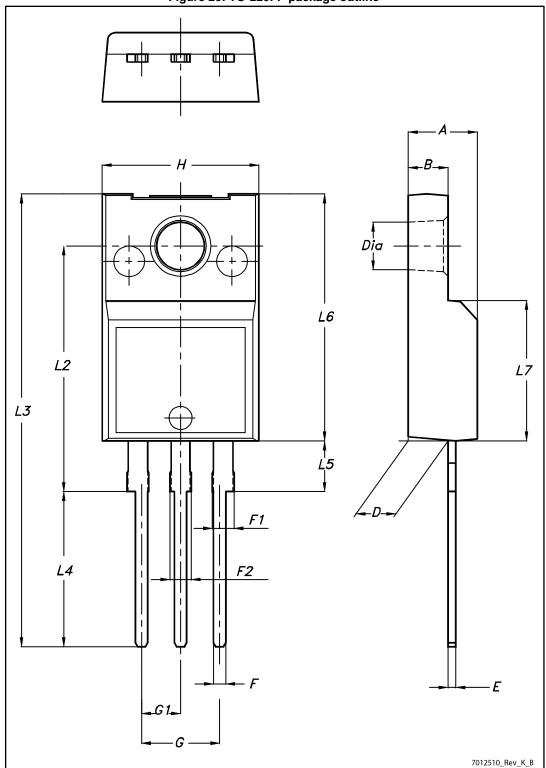


Table 9: TO-220FP package mechanical data

Dim	mm		
Dim.	Min.	Тур.	Max.
А	4.4		4.6
В	2.5		2.7
D	2.5		2.75
Е	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

Revision history STF27N60M2-EP

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
14-Jan-2016	1	First release.

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